Form PTO-1595 (Rev. 06/04) OMB No. 0651-0027 (exp. 6/30/2005)	11-23-2004 ARTMENT OF COMMERCE tent and Trademark Office	
RECORDATIC	tone and made mank office	
PATE	102888177 TSM04-0358 se record the attached documents or the new address(es) below.	
Name of conveying party(ies)/Execution Date(s):	2. Name and address of receiving party(ies)	
Hung-Wei Chen Ping-Kun Wu Chao-Hsiung Wang	Name: Taiwan Semiconductor Manufacturing Company. Ltd. Internal Address:	
Fu-Liang Yang Chenming Hu		
Execution Date(s) <u>H-WC: 10/29/04; P-KW, C-HW, & F-LY: 11/3/04; CH: 11/4/04</u>	Street Address: No. 8, Li-Hsin Rd. 6	
Additional name(s) of conveying party(ies) attached? Yes X No	Science-Based Industrial Park	
3. Nature of conveyance:	- City: <u>Hsin-Chu</u>	
X Assignment Merger	State: Taiwan	
Security Agreement Change of Name	Country: ROC Zip:300-77	
Government Interest Assignment		
Executive Order 9424, Confirmatory License Other		
	Additional name(s) & address(es) attached? Yes X No	
Additional numbers at	ttached? Yes X No	
5. Name and address to whom correspondence concerning document should be mailed: Name: Steven H. Slater	6. Total number of applications and patents involved:	
Slater & Matsil, L.L.P.	7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00	
Internal Address:	Authorized to be charged by credit card	
Street Address: 17950 Preston Rd.	X Authorized to be charged to deposit account Enclosed	
Suite 1000		
City: Dallas	None required (government interest not affecting title)	
State: <u>Texas</u> Zip: <u>75252-5793</u>	8. Payment Information	
Phone Number: <u>972-732-1001</u>		
Fax Number: <u>972-732-9218</u>	a. Credit Card Last 4 Numbers Expiration Date	
Email Address:slater@slater-matsil.com		
4 ECDOPER 00000187 501065 10989080 \	b. Deposit Account Number50-1065	
1 40.00 DA	Authorized User Name Steven H. Slater	
9. Signature: Signature	November 15, 2004 Date	
·	Total number of pages including cover	
Gregory T. Neugebauer, Reg. No. 53,378 Name of Person Signing	sheet, attachments, and documents: 3	

Documents to be recorded (Including cover sheet) should be faxed to (703) 306-5995, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

PATENT REEL: 015997 FRAME: 0275 004 11/10 04-21-09

10-NOV-2004 17:35

ATTORNEY DOCKET NO. TSM04-0358

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TSMC, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year,

TITLE OF INVENTION	CMOS Logic Gate Fabricated on Hybrid Crystal Orientations and Method of Forming Thereof			
SIGNATURE OF INVENTOR AND NAME	Hung-Wei Chen	Ping Kun V n	C/N/ Chao-Hsiung Wang	En-Liang Yang
DATE	Oce. 29, 2004	Nov. 3. 2006	NOV. 3, 2004	Ad NOV 2004
RESIDENCE (City, County, State)	Hsinchu, Taiwan R.O.C.	Hsin-Chu City, Taiwan R.O.C.	Hsin-Chu, Taiwan, R.O.C.	Hsin-Chu, Taiwan R.O.C.

TSM04-0358

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Assignment

PATENT REEL: 015997 FRAME: 0276

ATTORNEY DOCKET NO. TSM04-0358

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd. (TSMC), a corporation organized and existing under the laws of Taiwan, the Republic of China, with its principal office at No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C., is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TSMC, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TSMC, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to TSMC, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TSMC, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TSMC, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	CMOS Logic Gate Fabricated on Hybrid Crystal Orientations and Method of Forming Thereof		
SIGNATURE OF INVENTOR AND NAME	Chenming Hu		
DATE	Nov. 4, 2004		
RESIDENCE (City, County, State)	Hsin-Chu, Taiwan R.O.C. C.H. Alamo, CA, USA		

TSM04-0358

RECORDED: 11/15/2004

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Assignment

PATENT REEL: 015997 FRAME: 0277